

Features

- ## General Description

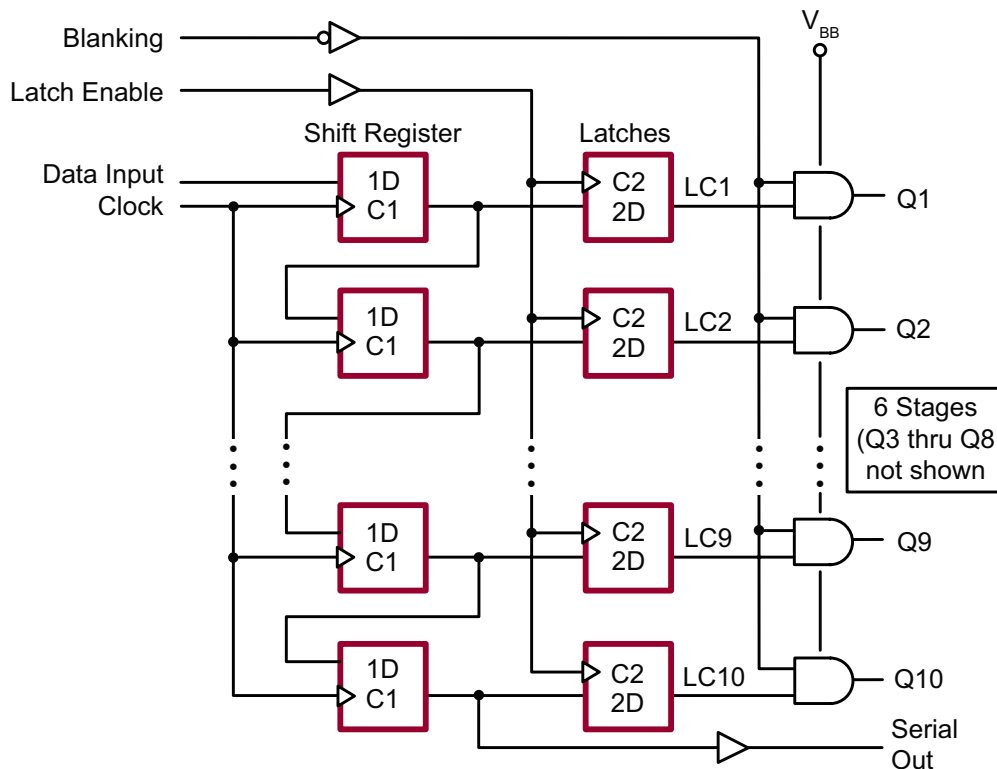
A 10-bit data word is serially loaded into the shift register on the positive-going transition of the clock. Parallel data is transferred to the output buffers through a 10-bit D-type latch while the latch enable input is high, and is latched when the latch enable is low. When the blanking input is high, all of the outputs are low.

Outputs are structures formed by double-diffused MOS (DMOS) transistors with output voltage ratings of 80V and 25mA source-current capability. All inputs are compatible with CMOS levels.

Applications

- ▶ High speed dot matrix print head driver
- ▶ VFD (vacuum fluorescent display) driver

Functional Block Diagram



Logic Diagram (positive logic)

Ordering Information

Part Number	Package Options	Packing
HV6810PJ-G	20-Lead PLCC*	48/Tube
HV6810PJ-G M910	20-Lead PLCC*	1000/Reel
HV6810WG-G	20-Lead SOW	1000/Reel

-G denotes a lead (Pb)-free / RoHS compliant package

* Obsolescence notice issued for the product in the 20-Lead PLCC package.

Absolute Maximum Ratings¹

Parameter	Value
Logic supply voltage, V_{DD}^2	7.5V
Driver supply voltage, V_{BB}^2	90V
Output voltage ²	90V
Input voltage ²	-0.3V to $V_{DD} + 0.3V$
Continuous total power dissipation at 25°C free-air temperature: ³	
20-Lead PLCC ³	1500mW
20-Lead SOW ³	1500mW
Operating temperature range	-45°C +85°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. All voltages are referenced to GND.

Notes:

- Over operating free-air temperature
- All voltages are referenced to V_{SS}
- For operation above 25°C ambient derate linearly to 85°C at 15mW/°C

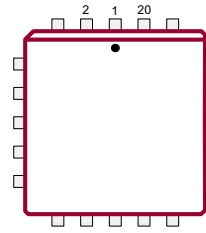
Typical Thermal Resistance

Package	θ_{ja}
20-Lead PLCC	66°C/W
20-Lead SOW	66°C/W

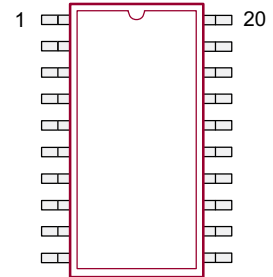
Recommended Operating Conditions

Sym	Parameter	Min	Typ	Max	Units	Conditions
V_{DD}	Supply voltage	4.5	-	5.5	V	---
V_{BB}	High supply voltage	20	-	80	V	---
V_{SS}	Supply voltage	-	0	-	V	---
V_{IH}	High-level input voltage (for $V_{DD} = 5.0V$)	3.5	-	5.3	V	---
V_{IL}	Low-level input voltage	-0.3	-	0.8	V	---
I_{OH}	Continuous high-level Q output current	25	-	-	mA	---
f_{CLK}	Clock frequency	-	-	5.0	MHz	---
T_A	Operating ambient temperature	-40	-	+85	°C	---

Pin Configuration



20-Lead PLCC
(top view)



20-Lead SOW
(top view)

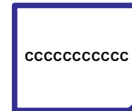
Product Marking

Top Marking



YY = Year Sealed
WW = Week Sealed
L = Lot Number
A = Assembler ID
C = Country of Origin*

Bottom Marking



* May be part of top marking

Package may or may not include the following marks: Si

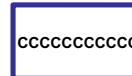
20-Lead PLCC

Top Marking



YY = Year Sealed
WW = Week Sealed
A = Assembler ID
L = Lot Number
C = Country of Origin*

Bottom Marking



* May be part of top marking

Package may or may not include the following marks: Si

20-Lead SOW

DC Electrical Characteristics

($V_{DD} = 5.0V$, $V_{BB} = 60V$, $V_{SS} = 0V$, $T_A = 25^\circ C$ unless otherwise noted)

Sym	Parameter		Min	Typ	Max	Units	Conditions
V_{OH}	High level output voltage	Q outputs	57.5	58	-	V	$I_O = +25mA$
		Serial output	4.0	4.5	-		$V_{DD} = +4.5V$, $I_{OL} = +100\mu A$
V_{OL}	Low level output voltage	Q outputs	-	0.15	1.0	V	$I_O = -100\mu A$, blanking input at V_{DD}
		Serial output	-	0.05	0.1		$V_{DD} = +4.5V$, $I_O = -100\mu A$
I_{OL}	Low level Q output current (pull-down current)		60	80	-	μA	$T_A = \text{Max}$, $V_{OL} = +0.7V$
$I_{O(OFF)}$	Off-state output current		-	-1.0	-15	μA	$V_O = 0V$, blanking input at V_{DD}
I_{IH}	High level input current		-		1.0	μA	$V_{IN} = V_{DD}$
I_{DD}	Supply current from V_{DD} (standby)		-	10	50	μA	All inputs at 0V, one Q output high
			-	10	50		All inputs at 0V, all Q outputs low
I_{BB}	Supply current from V_{BB}		-	0.05	0.1	mA	All outputs low, all Q outputs open
			-	0.05	0.1		All outputs high, all Q outputs open

* All typical values are at $T_A = 25^\circ C$ except for I_{OL} and $I_{O(OFF)}$.

AC Electrical Characteristics

(Timing requirements over recommended operating conditions)

Sym	Parameter	Min	Typ	Max	Units	Conditions
$t_{W(CKH)}$	Pulse duration, clock high	100	-	-	ns	---
$t_{W(LEH)}$	Pulse duration, latch enable high	100	-	-	ns	---
$t_{SU(D)}$	Setup time, data before clock	50	-	-	ns	---
$t_{H(D)}$	Hold time, data after clock	50	-	-	ns	---
$t_{CKH-LEH}$	Delay time, clock to latch enable high	50	-	-	ns	---
t_{PD}^*	Propagation delay time, latch enable to output	-	300	-	ns	---

* Switching characteristics, $V_{BB} = 60V$, $T_A = 25^\circ C$

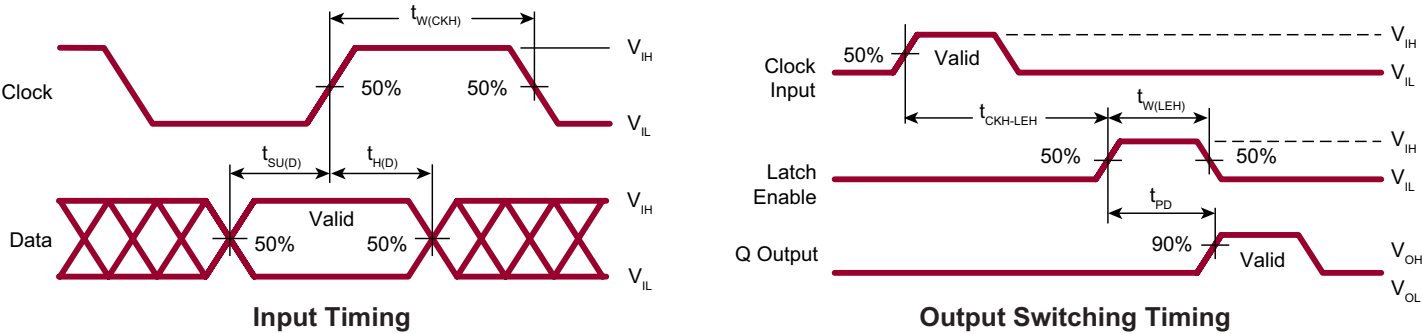
Power-up sequence should be the following:

1. Connect ground V_{SS}
2. Apply V_{DD}
3. Set all inputs (Data, CLK, Enable, etc.) to a known state
4. Apply V_{BB}

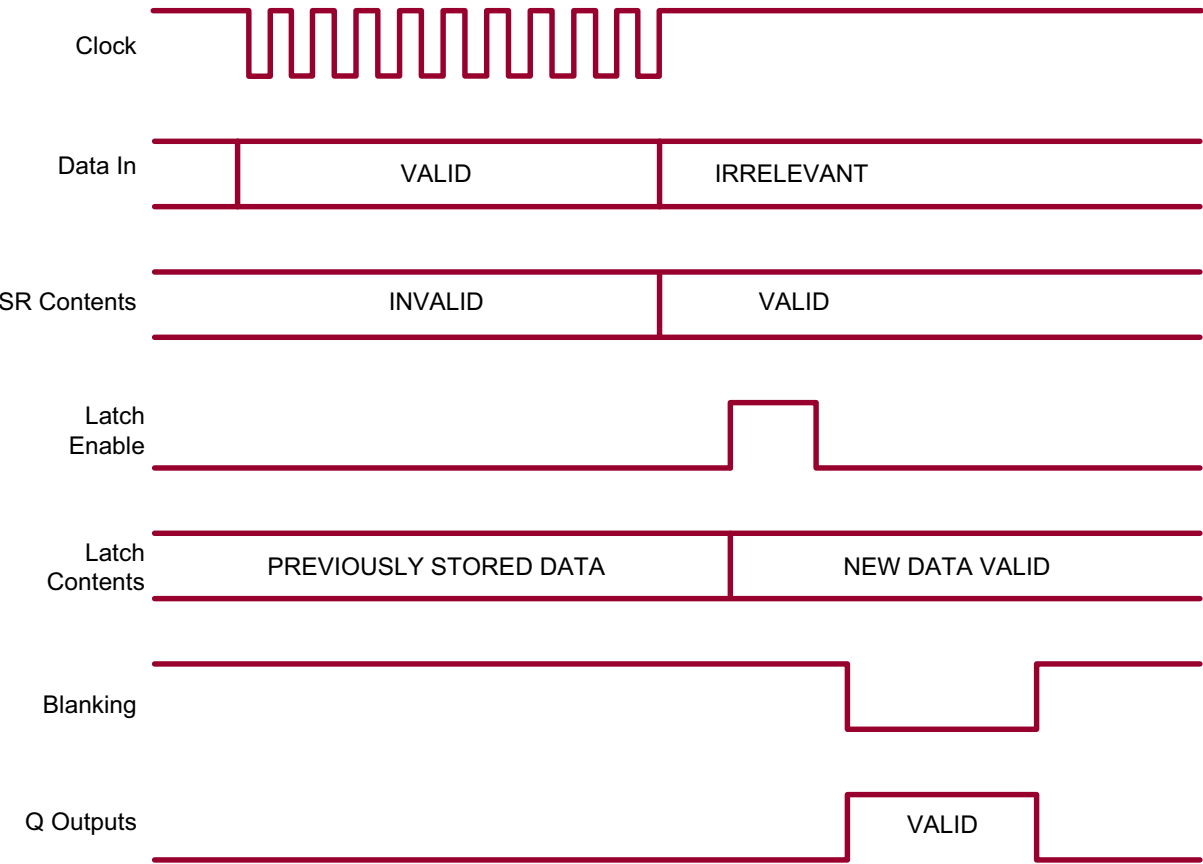
The V_{BB} should not drop below V_{DD} or float during operation.

Power-down sequence should be the reverse of the above.

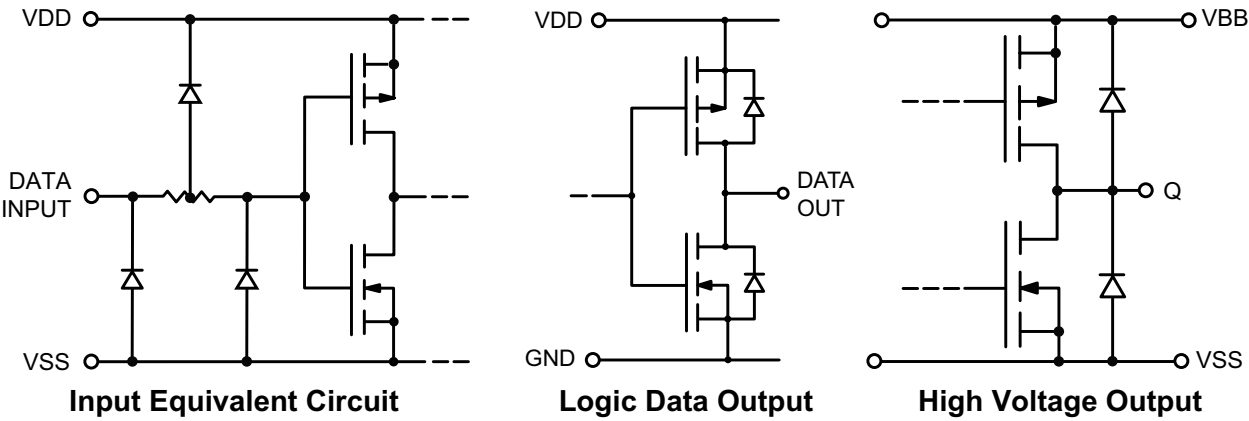
Switching Waveforms



Timing Diagram



Input and Output Equivalent Circuits



Function Table

Serial Data Input	Clock Input	Shift Register Contents						Serial Data Output	LE Strobe Input	Latch Contents						Blanking Input	Output Contents					
		I ₁	I ₂	I ₃	...	I _{N-1}	I _N			L ₁	L ₂	L ₃	...	L _{N-1}	L _N		O ₁	O ₂	O ₃	...	O _{N-1}	O _N
H		H	R ₁	R ₂	...	R _{N-2}	R _{N-1}	R _{N-1}	---	---						---	---					
L		L	R ₁	R ₂	...	R _{N-2}	R _{N-1}	R _{N-1}														
X		R ₁	R ₂	R ₃	...	R _{N-1}	R _N	R _N														
---	---	X	X	X	...	X	X	X	L	R ₁	R ₂	R ₃	...	R _{N-1}	R _N	L	P ₁ P ₂ P ₃ ... P _{N-1} P _N					
		P ₁	P ₂	P ₃	...	P _{N-1}	P _N	P _N	H	P ₁	P ₂	P ₃	...	P _{N-1}	P _N							
		---						---	---	X	X	X	...	X	X							

Notes:
L = Low logic level, H = High logic level, X = Don't care, P = Present state, R = Previous state
 = Low to high transition
 = High to low transition

Pin Description

20-Lead PLCC (PJ)

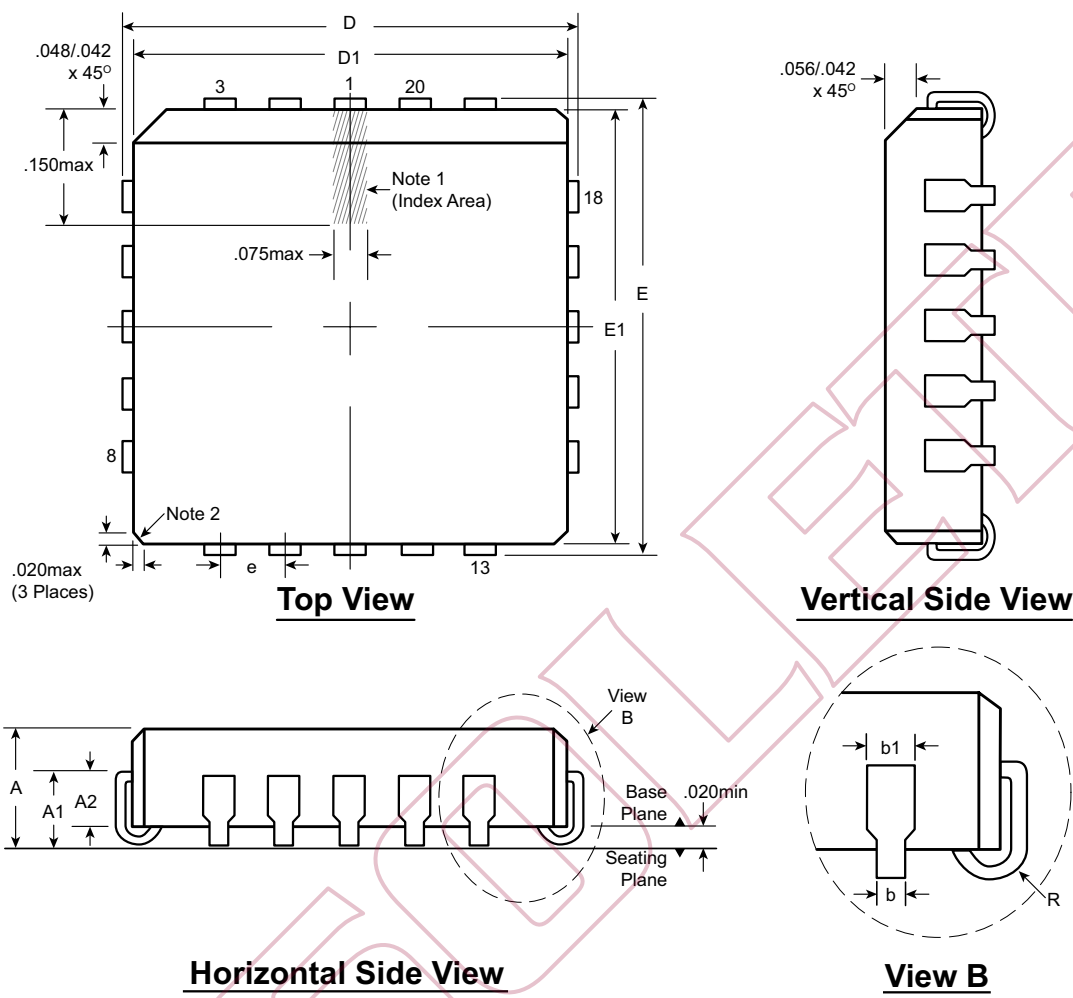
Pin #	Function	Description
1	Q8	High voltage output.
2	Q7	
3	Q6	
4	CLOCK	Input data is shifted into the data shift register on the positive edge of the clock.
5	N/C	No connection.
6	VSS	Usually $V_{SS} = 0V$, ground connection.
7	VDD	Low voltage power supply.
8	LE (STROBE)	When LE is high, the shift register output is latched to Q output. When LE stays high, the latches are in transparent mode.
9	Q5	High voltage output.
10	Q4	
11	Q3	
12	Q2	
13	Q1	
14	BLANKING	When blanking is high, all Q's are forced to a low state, regardless of data in each channel.
15	DATA IN	Input data for the input shift register.
16	N/C	No connection.
17	VBB	High voltage power supply.
18	SERIAL DATA OUT	Output data from the shift register.
19	Q10	High voltage output.
20	Q9	

Pin Description

20-Lead SOW (WG)

Pin #	Function	Description
1	Q8	High voltage output.
2	Q7	
3	Q6	
4	CLOCK	Input data are shifted into the data shift register on the positive edge of the clock.
5	VSS	Usually $V_{SS} = 0V$, ground connection.
6	N/C	No connection.
7	VDD	Low voltage power supply.
8	LE (STROBE)	When LE is high, the shift register output is latched to Q output. When LE stays high, the latches are in transparent mode.
9	Q5	High voltage output.
10	Q4	
11	Q3	
12	Q2	
13	Q1	
14	BLANKING	When blanking is high, all Q's are forced to a low state, regardless of data in each channel.
15	DATA IN	Input data for the input shift register.
16	VBB	High voltage power supply.
17	SERIAL DATA OUT	Output data from the shift register.
18	N/C	No connection.
19	Q10	High voltage output.
20	Q9	

20-Lead PLCC Package Outline (PJ)
.353x.353in body, .180in height (max), .050in pitch



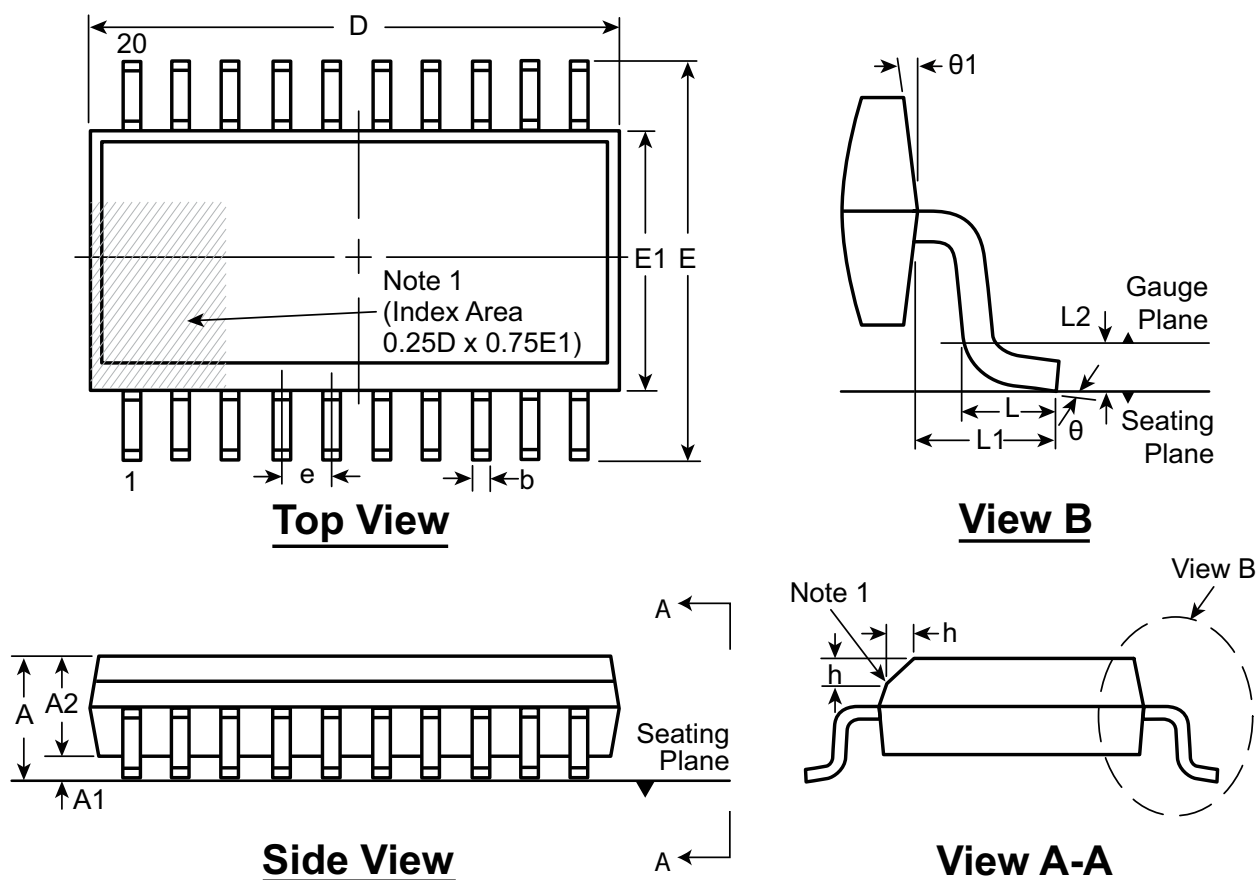
- Notes:**
1. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.
 2. Actual shape of this feature may vary.

Symbol		A	A1	A2	b	b1	D	D1	E	E1	e	R
Dimension (inches)	MIN	.165	.090	.062	.013	.026	.385	.350	.385	.350	.050 BSC	.025
	NOM	.172	.105	-	-	-	.390	.353	.390	.353		.035
	MAX	.180	.120	.083	.021	.032	.395	.356	.395	.356		.045

JEDEC Registration MS-018, Variation AA, Issue A, June, 1993.
Drawings not to scale.
Supertex Doc. #: DSPD-20PLCCPJ, Version C031111

20-Lead SOW (Wide Body) Package Outline (WG)

12.80x7.50mm body, 2.65mm height (max), 1.27mm pitch



Note:

1. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.

Symbol		A	A1	A2	b	D	E	E1	e	h	L	L1	L2	θ	θ1
Dimension (mm)	MIN	2.15*	0.10	2.05	0.31	12.60*	9.97*	7.40*	1.27 BSC	0.25	0.40	1.40 REF	0.25 BSC	0°	5°
	NOM	-	-	-	-	12.80	10.30	7.50		-	-			-	-
	MAX	2.65	0.30	2.55*	0.51	13.00*	10.63*	7.60*		0.75	1.27			8°	15°

JEDEC Registration MS-013, Variation AC, Issue E, Sep. 2005.

* This dimension is not specified in the JEDEC drawing.

Drawings are not to scale.

Supertex Doc. #: DSPD-20SOWWG, Version D041309.

(The package drawings in this data sheet may not reflect the most current specifications. For the latest package outline information go to <http://www.supertex.com/packaging.html>.)

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